



**ALPHA & OMEGA**  
SEMICONDUCTOR, INC.

March 2002

## AO4406

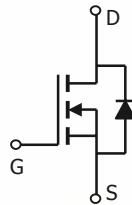
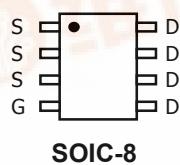
### N-Channel Enhancement Mode Field Effect Transistor

#### General Description

The AO4406 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device makes an excellent high side switch for notebook CPU core DC-DC conversion.

#### Features

$V_{DS} (V) = 30V$   
 $I_D = 11.5A$   
 $R_{DS(ON)} < 14m\Omega (V_{GS} = 10V)$   
 $R_{DS(ON)} < 16.5m\Omega (V_{GS} = 4.5V)$   
 $R_{DS(ON)} < 26m\Omega (V_{GS} = 2.5V)$



#### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current <sup>A</sup>	$I_D$	11.5	A
$T_A=70^\circ C$		9.6	
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	80	
Avalanche Current <sup>B,E</sup>	$I_{AV}$	25	A
Repetitive Avalanche Energy <sup>B,E</sup> $L=0.1mH$	$E_{AV}$	78	mJ
Power Dissipation	$P_D$	3	W
$T_A=70^\circ C$		2.1	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C

#### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	23	40	°C/W
Steady-State		48	65	°C/W
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	12	16	°C/W

**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	30			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=24\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$		1	5	$\mu\text{A}$
$I_{GSS}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 12\text{V}$			100	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	0.8	1	1.5	V
$I_{D(\text{ON})}$	On state drain current	$V_{GS}=4.5\text{V}, V_{DS}=5\text{V}$	60			A
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=12\text{A}$ $T_J=125^\circ\text{C}$		11.5	14	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=10\text{A}$		16	19.2	$\text{m}\Omega$
		$V_{GS}=2.5\text{V}, I_D=8\text{A}$		13.5	16.5	$\text{m}\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS}=5\text{V}, I_D=10\text{A}$	25	38		S
$V_{SD}$	Diode Forward Voltage	$I_S=10\text{A}, V_{GS}=0\text{V}$		0.83	1	V
$I_S$	Maximum Body-Diode Continuous Current				4.5	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		1630		pF
$C_{oss}$	Output Capacitance			201		pF
$C_{rss}$	Reverse Transfer Capacitance			142		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		0.8		$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g$	Total Gate Charge	$V_{GS}=4.5\text{V}, V_{DS}=15\text{V}, I_D=11.5\text{A}$		18		nC
$Q_{gs}$	Gate Source Charge			2.5		nC
$Q_{gd}$	Gate Drain Charge			5.5		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=1.2\Omega, R_{\text{GEN}}=3\Omega$		4		ns
$t_r$	Turn-On Rise Time			5		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			32		ns
$t_f$	Turn-Off Fall Time			5		ns
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=10\text{A}, dI/dt=100\text{A}/\mu\text{s}$		18,7		ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=10\text{A}, dI/dt=100\text{A}/\mu\text{s}$		19.8		nC

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

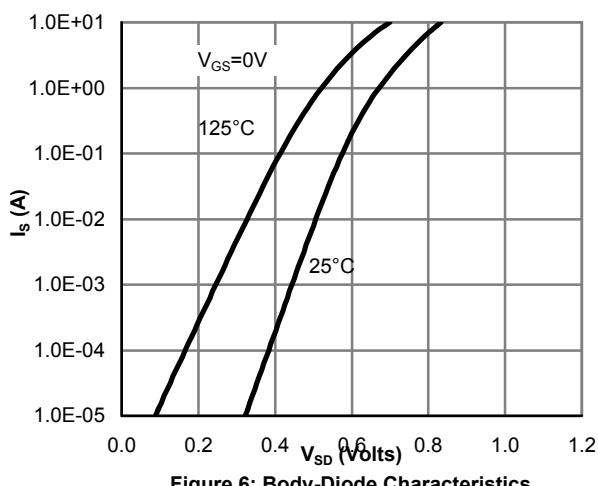
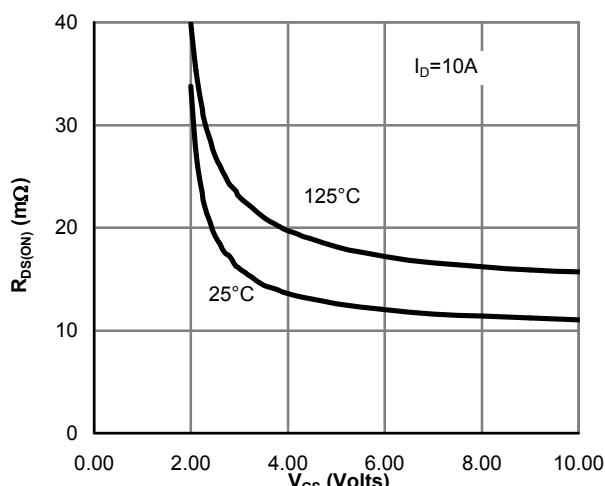
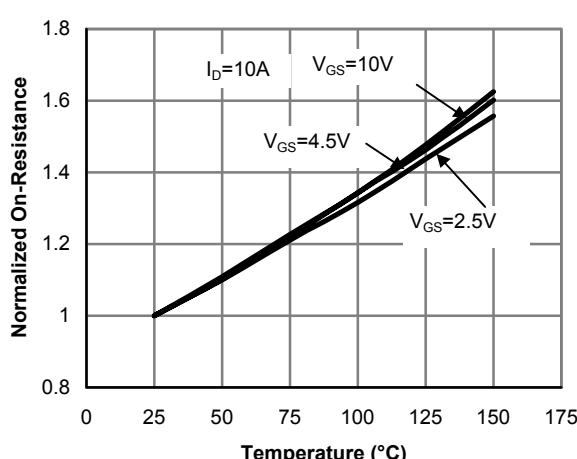
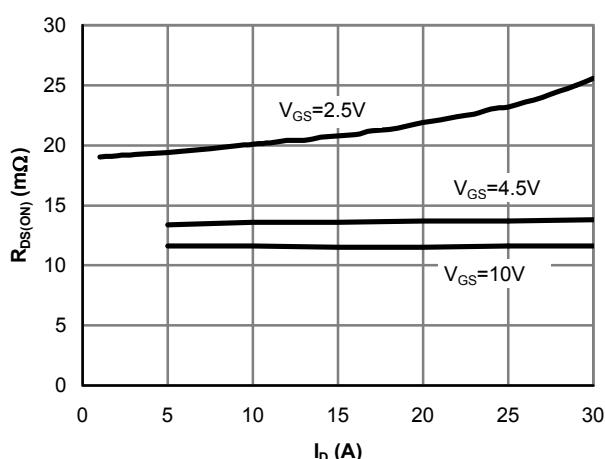
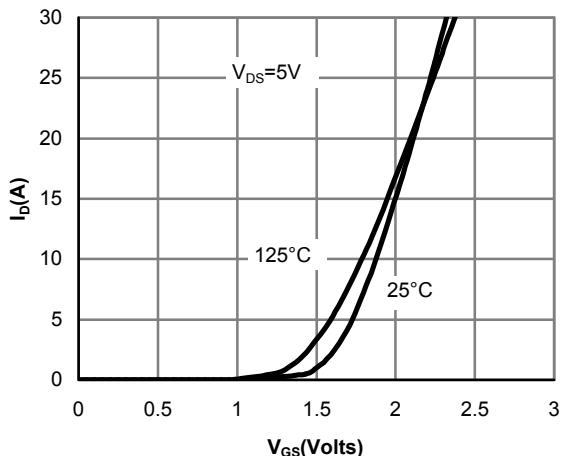
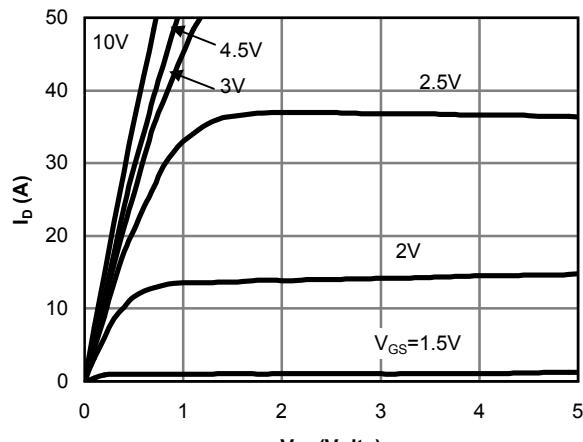
B: Repetitive rating, pulse width limited by junction temperature.

C. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta UL}$  and lead to ambient.

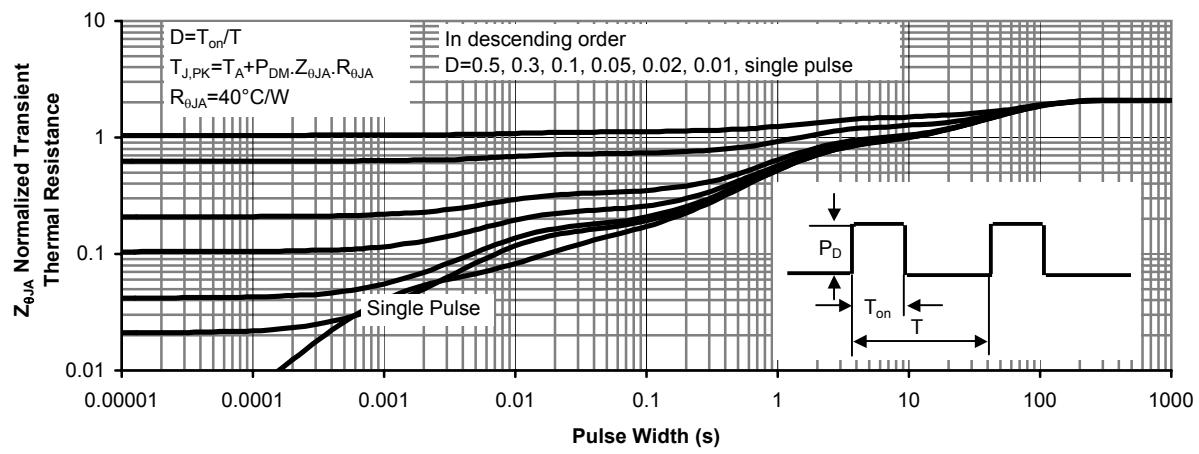
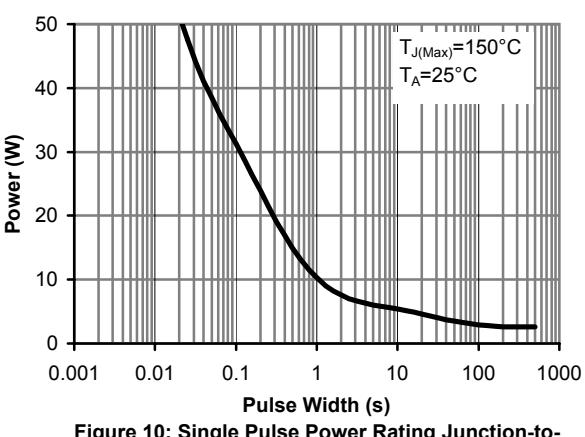
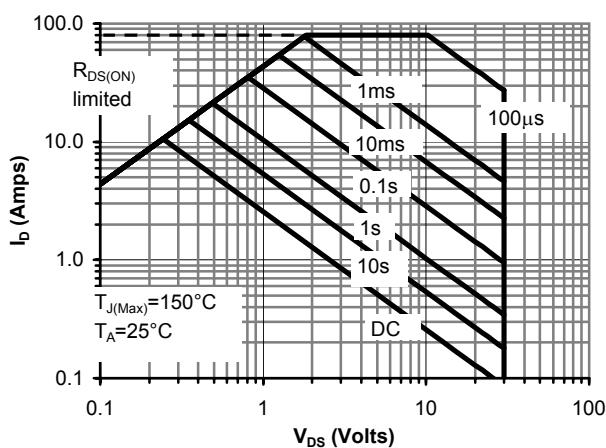
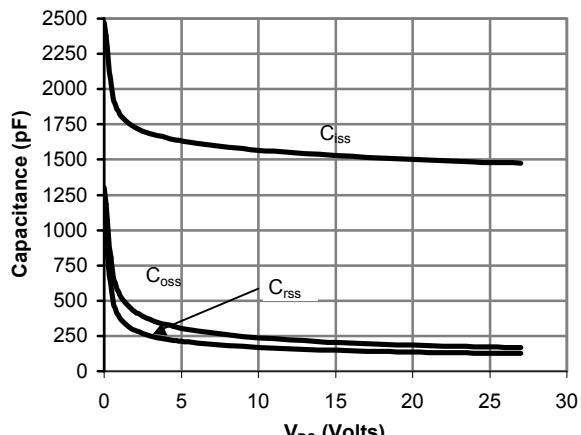
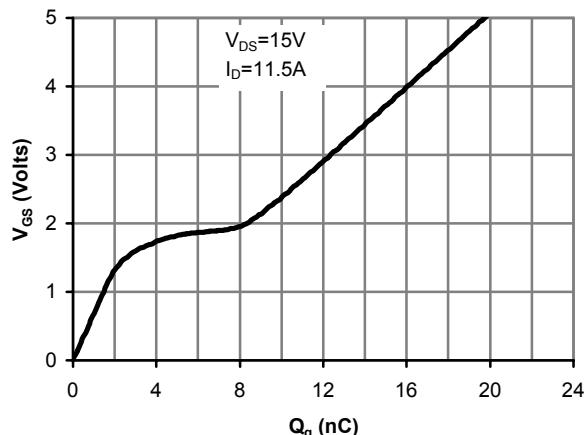
D. The static characteristics in Figures 1 to 6 are obtained using 80  $\mu\text{s}$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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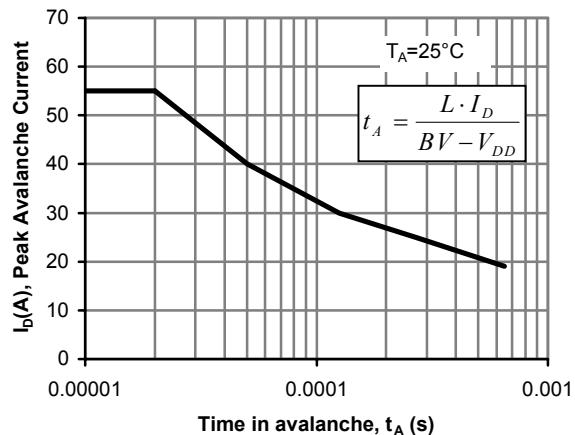
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

Figure 12: Avalanche capability

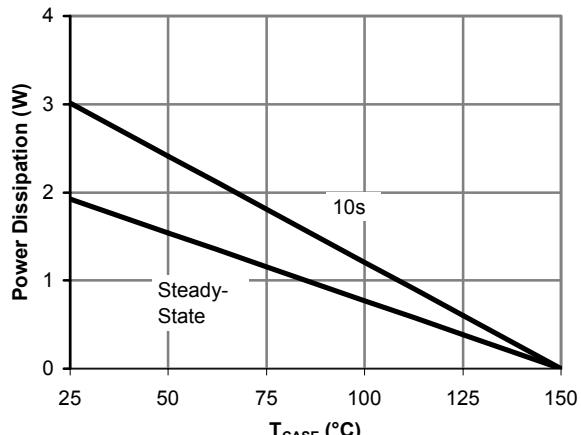
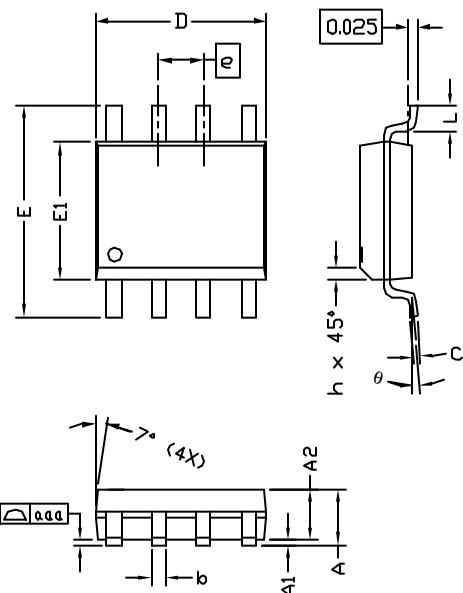


Figure 13: Power De-rating (Note A)



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## SO-8 Package Data

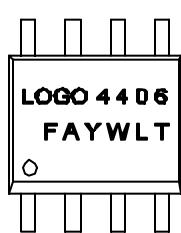


SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.45	1.50	1.55	0.057	0.059	0.061
A1	0.00	—	0.10	0.000	—	0.004
A2	—	1.45	—	—	0.057	—
b	0.33	—	0.51	0.013	—	0.020
c	0.19	—	0.25	0.007	—	0.010
D	4.80	—	5.00	0.189	—	0.197
E1	3.80	—	4.00	0.150	—	0.157
e	1.27 BSC			0.050 BSC		
E	5.80	—	6.20	0.228	—	0.244
h	0.25	—	0.50	0.010	—	0.020
L	0.40	—	1.27	0.016	—	0.050
aaa	—	—	0.10	—	—	0.004
$\theta$	0°	—	8°	0°	—	8°

NOTE:

1. LEAD FINISH: 150 MICROINCHES ( 3.8 um ) MIN.  
THICKNESS OF Tin/Lead ( SOLDER ) PLATED ON LEAD
2. TOLERANCE  $\pm 0.10$  mm ( 4 mil ) UNLESS OTHERWISE  
SPECIFIED
3. COPLANARITY : 0.10 mm
4. DIMENSION L IS MEASURED IN GAGE PLANE

### PACKAGE MARKING DESCRIPTION

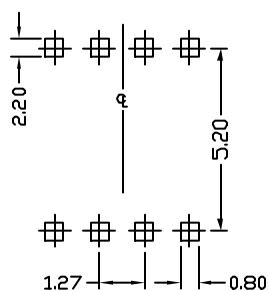


NOTE:  
 LOGO - AOS LOGO  
 4406 - PART NUMBER CODE.  
 F - FAB LOCATION  
 A - ASSEMBLY LOCATION  
 Y - YEAR CODE  
 W - WEEK CODE.  
 L N - ASSEMBLY LOT CODE

### SO-8 PART NO. CODE

PART NO.	CODE
AO4406	4406

### RECOMMENDED LAND PATTERN



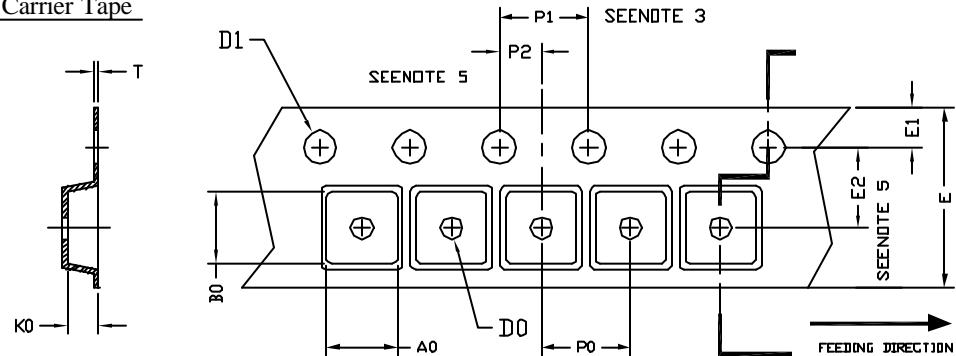
UNIT: mm



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## SO-8 Tape and Reel Data

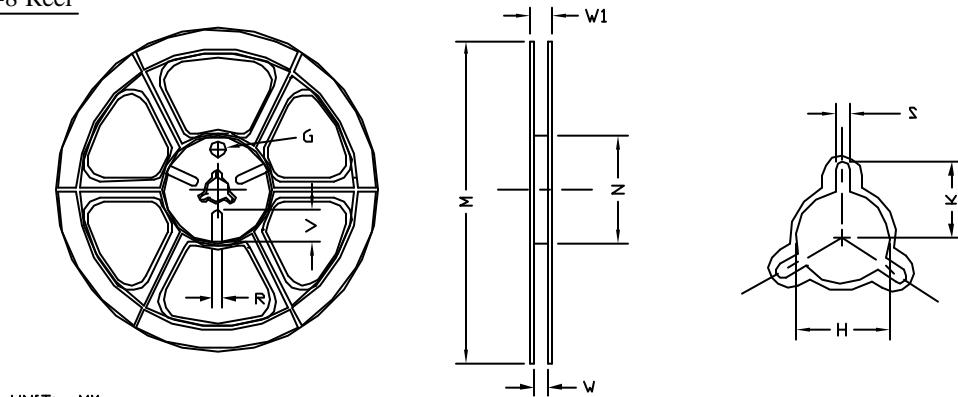
### SO-8 Carrier Tape



UNIT: MM

PACKAGE	$A_0$	$B_0$	$K_0$	$D_0$	$D_1$	$E$	$E_1$	$E_2$	$P_0$	$P_1$	$P_2$	$T$
SO-8 (12 mm)	6.40 $\pm 0.10$	5.20 $\pm 0.10$	2.10 $\pm 0.10$	1.60 $\pm 0.10$	1.30 $\pm 0.10$	12.00 $\pm 0.30$	1.75 $\pm 0.10$	5.50 $\pm 0.05$	8.00 $\pm 0.10$	4.00 $\pm 0.10$	2.00 $\pm 0.05$	0.25 $\pm 0.05$

### SO-8 Reel



UNIT: MM

TAPE SIZE	REEL SIZE	$M$	$N$	$W$	$W_1$	$H$	$K$	$S$	$G$	$R$	$V$
12 mm	$\phi 330$	$\phi 330.00$ $\pm 0.50$	$\phi 97.00$ $\pm 0.10$	13.00 $\pm 0.30$	17.40 $\pm 1.00$	$\phi 13.00$ $+0.50$ $-0.20$	10.60	2.00 $\pm 0.50$	---	---	---

### SO-8 Tape

Leader / Trailer  
& Orientation

